



1.0A SURFACE MOUNT SCHOTTKY

Product Summary

V _{RRM} (V)	I _O (A)	V _{F (MAX)} (V) @ +25°C	I _{R (MAX)} (mA) @ +25°C
40	1	0.66	0.02

Features and Benefits

- Reduced ultra-low forward voltage drop (V_F). Better efficiency and cooler operation.
- Reduced high temperature reverse leakage. Increased reliability against thermal runaway failure in high temperature operation
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description and Applications

Packaged in the robust industry-standard U-DFN1608-2 package, the SDM1M40LP8 provides very low V_{F} and excellent reverse-leakage stability at high temperatures. It is ideal for use as a rectifier, freewheel diode or blocking diode in:

- DC-DC Converters
- AC-DC Adaptors

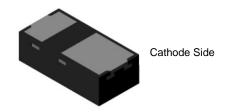
Mechanical Data

- Case: U-DFN1608-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.002 grams (Approximate)

U-DFN1608-2



Top View



Bottom View

Ordering Information (Note 4)

Part Number	Case	Packaging
SDM1M40LP8-7	U-DFN1608-2	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

U-DFN1608-2



 $D\underline{4}$ = Product Type Marking Code

Dot Denotes Cathode Side



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	<
Average Rectified Output Current	Ιο	1	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	8	А
Repetitive Peak Forward Current (tp = 1ms, duty cycle = 25%)	I _{FRM}	5	Α

Thermal Characteristics (Per Leg)

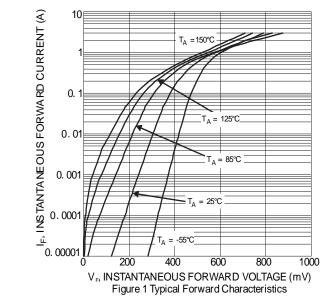
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	$R_{\theta JA}$	130	°C/W
Operating and Storage Temperature Range	T_{J}, T_{STG}	-65 to +150	°C

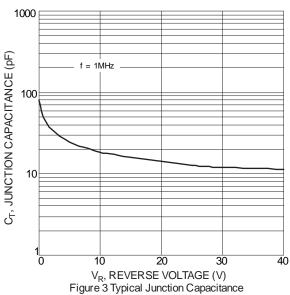
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop (Note 6)		_	0.49	0.56		I _F = 0.5A, T _J = +25°C
		_	0.42	_	\/	I _F = 0.5A, T _J = +125°C
	V _F	_	0.59	0.66	V	I _F = 1A, T _J = +25°C
		_	0.55	_		I _F = 1A, T _J = +125°C
		_	0.0006	0.004		V _R = 10V, T _J = +25°C
Leakage Current (Note 6)	I _R	_	0.002	0.02	mA	$V_R = 40V, T_J = +25^{\circ}C$
		_	0.80	_		V _R = 40V, T _J = +125°C
Reverse Recovery Time	trr	_	8.4	_	ns	IF = 10mA, Irrm = 0.1Ir,Ta = +25°C
Total Capacitance	C _T	_	25	_	pF	VR = 5V, f = 1MHz

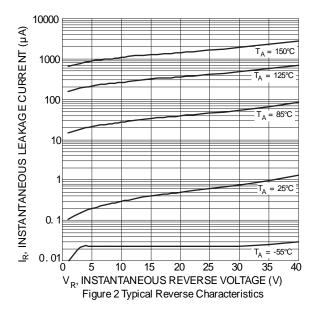
Notes:

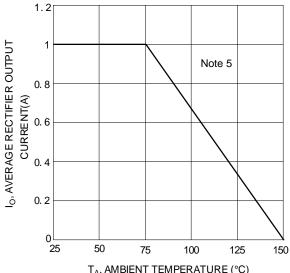
- 5. Test with FR-4 PC board 1-inch sq. copper pad, 2oz.
- 6. Short duration pulse test used to minimize self-heating effect.









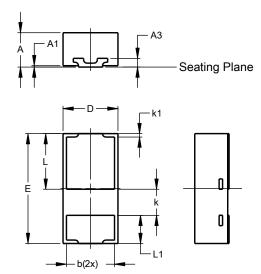


 T_A , AMBIENT TEMPERATURE (°C) Figure 4 DC Forward Current Derating Curve



Package Outline Dimensions

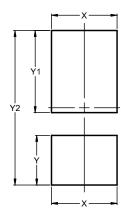
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	U-DFN1608-2				
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0.00	0.05	0.02		
A3	1	1	0.127		
b	0.65	0.75	0.70		
D	0.75	0.85	0.80		
Е	1.55	1.65	1.60		
k	0.38 BSC				
k1	0.05 BSC				
L	0.76	0.86	0.81		
L1	0.36	0.46	0.41		
All	All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.800
Y	0.610
Y1	1.010
Y2	1.900



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